

Products & Applications

>> Home > Products & Applications > Soldering/Desoldering > MFR-2200 Series > MFR-2211



Technical Specificatio MFR-2210, MFR-2220, MI 2241

Input Line Voltage / Freq 100- 240 VAC, 50/60 Hzgr Power Consumption:130 **Output Power Maximum:** 60 Watts max. at 22°C pe Idle Temperature Stabilit Ambient Operating Temp 10- 40°C (50°F - 104°F) Maximum Enclosure Tem Power Cord 3-Wire:183cr (S = 600 Volt Service Cora Volt, T = Thermoplastic) Hand-piece Cable Length L=122cm (48"), burn resist Hand-piece Connector:8-Tip-to-Ground Potential: Tip-to-Ground Resistance Certification / Marking:c **Power Supply Dimension:** 170mm x 200mm x 152.5n Workstand Dimensions w 100 mm x 200 mm x 100 n Surface Resistivity:105-10

Weight:

MFR-PS2200: 2.97 kg (6.5 Hand-piece: 0.115 kg (0.2

MFR-2211

This system includes two cartridge hand-pieces to suit even the most demanding applications, including SMD removal and placement applications.

Key Features & Benefits

- SmartHeat® Technology provides exceptional power for high thermal demand applications
- Dual simultaneous outputs allow for single or dual operator use
- Allows one operator to use one or two hand-pieces together
- A comprehensive range of cartridges for maximum flexibility
- Hand-pieces are ergonomic for operator safety and comfort

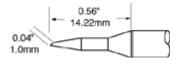
MFR-2211 Dual output, two cartridge soldering hand-piece, workstand

Part No.	Description
MFR-2211	Dual output, two cartridge soldering hand-piece, workstand
System Components	
MFR-H1-SC	Hand-piece, Soldering Cartridge
MFR-PS2200	Power Supply, Dual Simultaneous Output
WS1	Auto Sleep Workstand

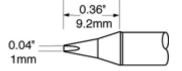
Contents subject to change without notice

Standard Soldering Tip Cartridges

The Standard Soldering Tip Cartridges are used with the MFR-H1-SC Hand-piece and have been designed to deliver outstanding performance for the majority of point-to-point soldering and basic rework applications. The geometries within the range have been optimized to deliver maximum accessibility combined with optimal thermal efficiency within a narrow cartridge diameter.



SFP-BVL10 Bevel Cartridge, 60° 1.0mm (.04")



SFP-CH10 Chisel Cartridge, 30° 1.0mm (.04") Workstand: 0.686 kg (1.5⁻ MFR-PS2200 w/ 2 hand-p 4.57 kg (10.08 lbs)

Soldering Tip Heate

With hand soldering, the solder connection, v substrate and withou throughput. All of the s⁻ tips & rework cartridg with glass fiber (FR4) denoted by the second l "F". For example: SFP-(CNL10.

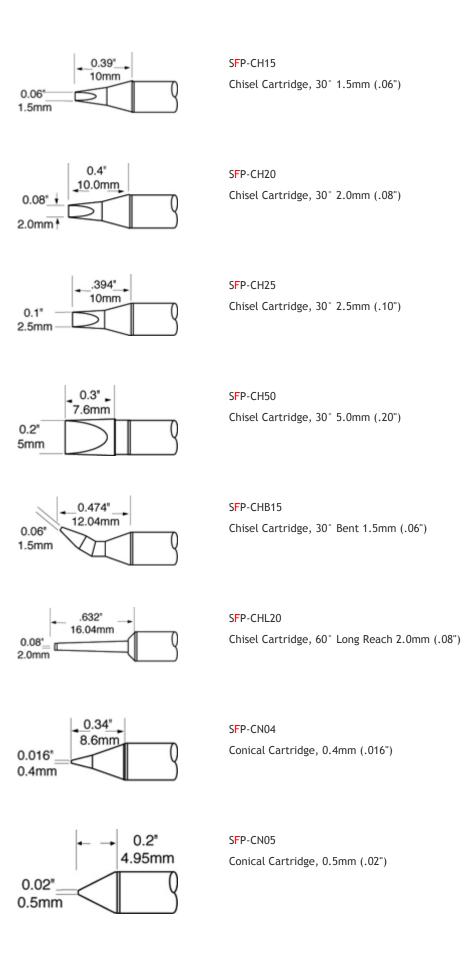
However, some specia working with ther temperature sensitive ceramic hybrids or International has deve that quickly deliver th operate at temperature of substrate damage. replacing the "F" in the for temperature sensitiv loads. Please contact <u>y</u> for information and av heaters. For example: S

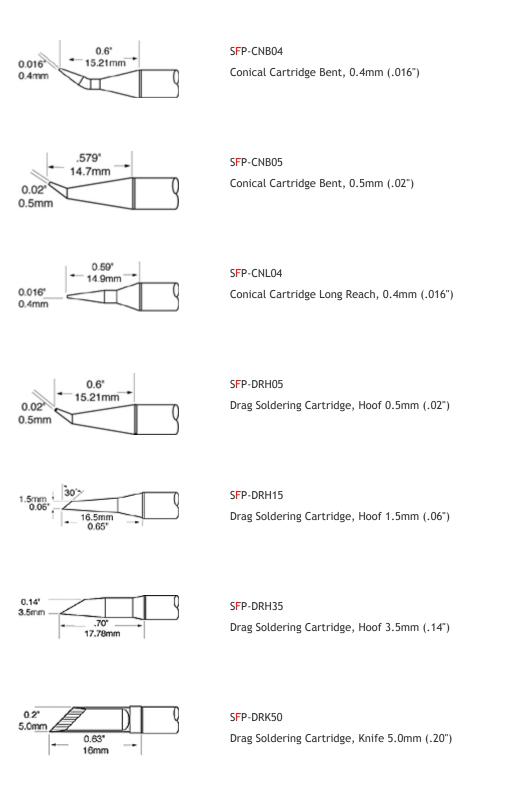
> F = Standard T = Tempera C = Ceramic



MFR Series S

Page 2 of 7





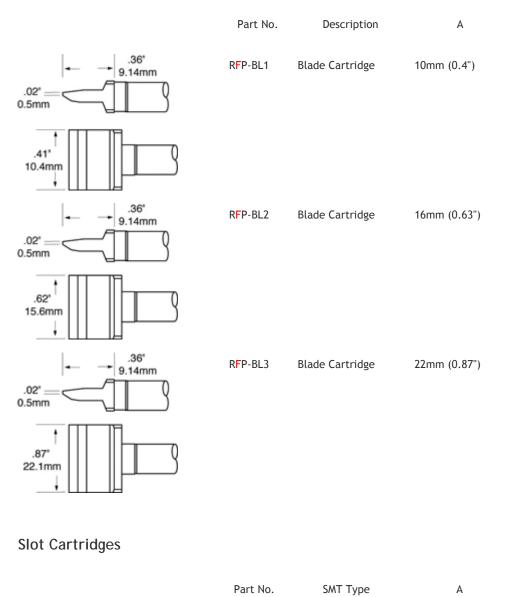
To order specialty versions of the Soldering Tip Cartridges replace the "F" in the part number with the appropriate letter designate for your application when ordering:

T = Temperature Sensitive C = Ceramic or Heavy Load

Rework Cartridges

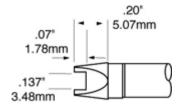
The Rework Cartridges are used with the MFR-HSR Soldering & Rework Hand-piece for conduction rework of surface mount components. The geometries are compatible with common SMT Chip and SOIC components.

Blade Cartridges



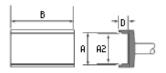


RFP-SL2



Tunnel Cartridges

Dimensions in mm (")



Part	SMT	A2	А	В	D
No.	Туре				
RFP-	SOIC	5.18	5.18	4.32	3.22
DL1	14-16	(.204)	(.204)	(.17)	(.127)

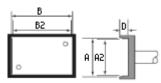
1206 Chip Package

3.48mm (.137")

RFP-	SOIC 8	5.18	5.18	4.32	2.29
DL2		(.204)	(.204)	(.17)	(.090)
RFP-	SOIC	6.86	6.86	11.18	2.29
DL13	16	(.270)	(.270)	(.44)	(.090)

Quad Cartridges

Dimensions in mm (")



Part	SMT	A2	А	B2	В	D
No.	Туре					
RFP-	PLCC	11.43	12.70	13.97	15.24	3.81
QD4	32	(.450)	(.500)	(.550)	(.600)	(.150)

RFP-	PLCC	16.76	17.78	16.76	17.78	3.81
QD6	44	(.660)	(.700)	(.660)	(.700)	(.150)
RFP-	PLCC	24.38	25.27	24.38	25.27	5.59
QD7	68	(.960)	(.995)	(.960)	(.995)	(.220)

R <mark>F</mark> P- QD10				19.30 (.760)		
R <mark>F</mark> P-	TQFP	12.32	13.34	12.32	13.34	2.79
QD15	80	(.485)	(.535)	(.485)	(.535)	(.110)
RFP-	QFP	16.13	16.13	16.13	16.13	3.30
QD19	44	(.635)	(.635)	(.635)	(.635)	(.130)
RFP-	QFP	16.51	16.51	22.48	22.48	3.30
QD20	100	(.650)	(.650)	(.885)	(.885)	(.130)

Company
C

T = Temperature Sensitive C = Ceramic or Heavy Load